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To the Commissioner for Patents. Please record the attached original documents or copies thereof.

## 1. Name of Conveying Party(ies):

Cheng Hsun TSAI  
Chen Lien CHIANG

## 2. Name and Address of Receiving Party(ies):

Name: RamTek Technology Inc.

Street Address: 3F, No. 5, Lane 16, Sec. 2, Szu  
Chuan Rd.

## 3. Nature of Conveyance:

- ☒ Assignment ☐ Merger  
☐ Security Agreement ☐ Change of Name  
☐ Other:

Execution Date: 11/04/2005

City, State, Zip: Pan Chiao City, Taipei, Taiwan

☐ Additional name(s) and address(es) attached.

## 4. (A) Patent Application Number(s):

## 4. (B) Patent Number(s):

01/25/2006 SHASSEN1 00000034 11336918

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40.00 OP

If this document is being filed together with a new  
application, the execution date of the application is: 11/04/2005☐ Additional Numbers Attached.

Title: METHOD AND SOCKET ASSEMBLY FOR TESTING BALL GRID ARRAY PACKAGE IN REAL SYSTEM

Attorney Docket No.: TSAI3170/EM

5. Name and Address of Party to whom Correspondence Concerning this  
Document Should be Mailed:

Name: Eugene Mar

Bacon & Thomas, PLLC  
625 Slaters Lane Fourth Floor  
Alexandria, VA 2231423364  
CUSTOMER NUMBERTotal Number of Applications and  
Patents Involved:

1

7. Total Fee:  
(37 CFR 3.41)

\$40.00

☒ Enclosed☐ Authorized to be charged to deposit account

## 8. Deposit Account Number:

02-0200

## 9. Statement and Signature:

**To the best of my knowledge and belief, the foregoing is true and correct and any attached copy is a true  
copy of the original document.**

Eugene Mar

Name of Person Signing

Signature

January 23, 2006

Date

Total number of pages including cover sheet, attachments and document: 3

**ASSIGNMENT BY INVENTOR(S) OF U.S. APPLICATION**

WHEREAS, I am the original, first and sole inventor and I own (if only one name is listed below) or an original, first and joint inventor and the joint inventors own (if plural names are listed below) (referred to as "ASSIGNOR" below) the subject matter which is claimed and for which a patent is sought on the invention (referred to as the "INVENTION" below) entitled:

Title: **METHOD AND SOCKET ASSEMBLY FOR TESTING BALL GRID ARRAY PACKAGE IN REAL SYSTEM**

the specification of which (check one):

<input checked="" type="checkbox"/>	V	is executed on even date herewith.	
<input type="checkbox"/>		was filed on (day-month-year)	as U.S. Application Number
<input type="checkbox"/>		was filed on (day-month-year)	as PCT Application Number
<input type="checkbox"/>		was executed on the following date(s) (day-month-year)	

WHEREAS, **RamTek Technology Inc.**

having a postal address of **3F, No. 5, Lane 16, Sec. 2, Szu Chuan Rd., Pan Chiao City, Taipei, Taiwan, R.O.C.**

(referred to as "ASSIGNEE" below) desires to acquire the entire right, title and interest in and to the same in the U.S.;

NOW, THEREFORE, for good and valuable consideration, the receipt and adequacy of which is hereby acknowledged, ASSIGNOR, by these presents does sell, assign and transfer unto ASSIGNEE, the entire right, title, and interest in and to said INVENTION and application throughout the United States of America, including any and all patents granted on any division, continuation, continuation-in-part and reissue of said application.

ALSO, ASSIGNOR hereby agrees to execute any documents that legally may be required in connection with the filing, prosecution and maintenance of said application or any other patent applications in the United States for said INVENTION, including additional documents that may be required to affirm the rights of ASSIGNEE in and to said INVENTION, all without further consideration. ASSIGNOR also agrees, without further consideration and at ASSIGNEE's expense, to identify and communicate to ASSIGNEE at ASSIGNEE's request documents and information concerning the INVENTION that are within ASSIGNOR's possession or control, and to provide further assurances and testimony on behalf of ASSIGNEE that lawfully may be required of ASSIGNOR in respect of the prosecution, maintenance and defense of any patent application or patent encompassed within the terms of this instrument. ASSIGNOR's obligations under this instrument shall extend to ASSIGNOR's heirs, executors, administrators and other legal representatives.

ALSO, ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all patents referred to above to ASSIGNEE, as the ASSIGNEE of the entire right, title and interest in and to the same, for ASSIGNEE's sole use and behoof; and for the use and behoof of ASSIGNEE's legal representatives and successors, to the full end of the term for which such patent may be granted, as fully and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made.

ASSIGNOR authorizes any member of the firm of Bacon & Thomas, PLLC to insert or complete any information in this document needed to effect its recordal in the U.S. Patent and Trademark Office.

Full Name of First or Sole Inventor <b>TSAI, CHENG HSUN</b>	Post Office Address <b>3F, No. 5, Lane 16, Sec. 2, Szu Chuan Rd., Pan Chiao City, Taipei, Taiwan, R.O.C.</b>
Citizenship <b>Taiwan</b>	Residence (city, and either state or foreign country, MPEP §605.02) <b>Taiwan</b>
Date <b>2005.11. 04</b>	Signature <i>Cheng / Hsun Tsa</i>

☒ See following page(s) for additional joint inventors.

(06Nov2001)

ATTORNEY/DOCKET No:

**SUPPLEMENTAL PAGE FOR A  
ASSIGNMENT BY INVENTOR (S) OF U.S. APPLICATION**

Full Name of Joint Inventor <b>CHIANG, CHEN LIEN</b>	Post Office Address 3F, No. 5, Lane 16, Sec. 2, Szu Chuan Rd., Pan Chiao City, Taipei, Taiwan, R.O.C.
Citizenship <b>Taiwan</b>	Residence (city, and either state or foreign country, MPEP §605.02) <b>Taiwan</b>
Date <b>2005.11.04</b>	Signature <i>Cheng Lien Chiang</i>

Full Name of Joint Inventor	Post Office Address
Citizenship	Residence (city, and either state or foreign country, MPEP §605.02)
Date	Signature

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Date	Signature

☐

See following page(s) for additional joint inventors.

(09Jan2004)